



NCT5927W

Nuvoton

Level translating

I²C-bus/SMBus Repeater

Date: Nov.14, 2014 Revision: 1.01



	PAGES	DATES	VERSION	MAIN CONTENTS
1		2012/07/13	0.1	Draft version.
2		2012/08/15	0.2	 Modify application circuit on fig2 Modify test conditions and dynamic characteristics
3		2013/05/24	0.5	1. Modify DC/AC specification
4		2013/10/02	0.6	1, Modify B port VIL 2, Modify B port low level current
5		2013/10/21	1.0	 Modified capacitance values in general description Modified A Port VIL
6	1	2014/11/14	1.01	1. Update the typo in the General description
				0

NCT5927W Datasheet Revision History







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1. GENERAL DESCRIPTION

The NCT5927W is a CMOS integrated circuit that provides bidirectional level shifting between higher voltage (2.2 V to 5.5 V) and low voltage (down to 0.8 V) up to 1MHz for SMBusTM applications. While retaining all the operating modes and features of the I^2 C-bus system during the level shifts, it also permits extension of the I^2 C-bus by providing bidirectional buffering for both the data (SDA) and the clock (SCL) lines, thus enabling two buses at lower speeds. The SDA and SCL pins are 5V tolerant and are high-impedance when the NCT5927W is unpowered.

The NCT5927W drivers are not enabled unless V_{CCB} is above 2.2 V and V_{CCA} is above 0.8 V. The EN pin can also be used to turn the drivers on and off under system control. Caution should be observed to only change the state of the enable pin when the bus is idle.

The output pull-down on the B-side internal buffer LOW is set for approximately 0.55 V, while the input threshold of the internal buffer is set about 150 mV lower (0.4 V). When the B-side I/O is driven LOW internally, the LOW is not recognized as a LOW by the input. This prevents a lock-up condition from occurring. The output pull-down on the A-side drives a hard LOW and the input level is set at $0.3V_{CCA}$ to accommodate the need for a lower LOW level in systems where the low voltage side supply voltage is as low as 0.8 V. The NCT5927W is packaged in MSOP-8 type.

2. FEATURES

- 2 channels, bidirectional voltage level from 0.8V to 5.5V and from 2.2V to 5.5V
- A side operating supply voltage VCCA range from 0.8V to 5.5V
- B side operating supply voltage VCCB range from 2.2V to 5.5V
- Isolates Input/output sides
- I²C® Compatible System Management bus (SMBusTM) operated up to 1MHz
- High active's enable input
- 5V tolerant I²C-bus and active high enable pin
- high-impedance for I²C-bus pins in power-off
- 8-pin MSOP Green Package (Halogen-free)
- ESD protection exceeds 5500V HBM, 500V MM, and 1000V CDM
- Latch-up exceeds 100mA

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3. BLOCK DIAGRAM



Figure 1 – Functional Diagram

4. PIN CONFIGURATION







4.1 Pin Description

PIN	NAME	DESCRIPTION
1	V _{CCA}	A-side supply voltage (0.8V to 5.5V)
2	SCLA	Serial clock bus, A side.
3	SDAA	Serial data bus, A side.
4	GND	Supply ground
5	EN	Active-high repeater enable input.
6	SDAB	Serial data bus, B side.
7	SCLB	Serial clock bus, B side.
8	V _{CCB}	B-side supply voltage (2.2V to 5.5V)



5. FUNCTIONAL DESCRIPTION

A typical application is shown in Figure 2. In this example, the memory is running on a 2.2V I^2 C-bus while CPU is connected to a 0.9V bus. Both buses run at 1MHz.



Figure 2 - Typical Application

The NCT5927W is 5V tolerant, so it does not require any additional circuitry to translate between 0.8V to 5.5 V bus voltages and 2.2V to 5.5V bus voltages.

When the A-side of the NCT5927W is pulled LOW by a driver on the I²C-bus, a comparator detects the falling edge when it goes below 0.3VccA and causes the internal driver on the B-side to turn on, causing the B-side to pull down to about 0.55 V. When the B-side of the NCT5927W falls, first a CMOS hysteresis type input detects the falling edge and causes the internal driver on the A-side to turn on and pull the A-side pin down to ground. In order to illustrate what would be seen in a typical application, refer to Figure 3 and Figure 4. If the bus master in Figure 3 were to write to the slave through the NCT5927W, waveforms shown in Figure 6 would be observed on the A bus. This looks like a normal I²C-bus transmission except that the HIGH level may be as low as 0.8 V, and the turn on and turn off of the acknowledge signals are slightly delayed.

On the B bus side of the NCT5927W, the clock and data lines would have a positive offset from ground equal to the VoL of the NCT5927W B side. After the 8th clock pulse, the data line will be pulled to the VoL of the NCT5927W in this example. At the end of the acknowledge, the level rises from the LOW level set by the driver in the NCT5927W while the A bus side rises above 0.3VccA, then it continues HIGH. It is important to note that any arbitration or clock stretching events require that the LOW level on the B bus side at the input of the NCT5927W (VIL) be at or below 0.4 V to be recognized by the *Release Date: Nov. 2014*



NCT5927W and then transmitted to the A bus side. The NCT5927W includes a VccA over voltage disable that turns the channel off if 0.4VccA+0.8V> VccB.



Figure 3 - Bus A (0.8V to 5.5V bus) waveform



Figure 4 - Bus B (2.2V to 5.5V bus) waveform

5.1 Enable Pin

The EN pin is active HIGH with thresholds reference to VCCB with an internal pull-up to VCCB and allows the user to select when the repeater is active. This can be used to isolate a badly behaved slave on power-up until after the system power-up reset. It should never change state during and I^2C -bus operation because disabling during a bus operation will hang the bus and enabling part way through a bus cycle could confuse the I^2C -bus parts being enabled.

The enable pin should only change state when the global bus and the repeater port are in an idle state to prevent system failures.

INPUT EN	FUNCTION
No L	Output Disable
32. On	SDAA = SDAB
	SCLA = SCLB



6. ELECTRICAL CHARACTERISTICS

6.1 Absolute Maximum Ratings

PARAMETER	RATING	UNIT		
Power Supply Voltage (V _{CCA} , V _{CCB})	-0.5 to 6.0	V		
Input/Output Voltage	-0.5 to 6.0	v		
Operating Temperature (in free air)	-40 to + 85	°C		
Storage Temperature	-55 to +125	°C		
Junction temperature	125	°C		

Note: Exposure to conditions beyond those listed under Absolute Maximum Ratings may adversely affect the life and reliability of the device.

6.2 DC Characteristics

 V_{CCA} =0.8V to 5.5V^[1]; V_{CCB} =2.2V to 5.5V; GND=0V; T_{amb} =-40 °C to 85°C; unless otherwise specified.^[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
V _{CCB}	Supply voltage, B-side bus		2.2	-	5.5	V
V_{CCA}	Supply voltage, A-side bus		0.8	-	5.5	V
I _{CC(VCCA)}	Supply current on pin V _{CCA}	V _{CCA} = 5.5V	-	-	50	uA
		Both channels HIGH;			2.5	mA
I _{CCH}	HIGH-state supply current	V _{CCB} = 5.5V;	-	2		
		$V_{CCB} = 5.5V;$ $SDAn = SCLn = V_{CC(n)}$ Both channels LOW; $V_{CC} = 5.5V;$				
		Both channels LOW;				
ICCL	LOW-state supply current	V _{CC} = 5.5V;	- 1.8		2.9	mA
		One SDA and SCL = GND; other SDA and SCL = open				
nput and	output SDAB and SCLB					
V _{IH}	HIGH-level input voltage		$0.7V_{\text{CCB}}$	-	5.5	V
V _{IH} V _{IL}	HIGH-level input voltage		0.7V _{ССВ} -0.5	-	5.5 +0.4	-
- (Q3						V
V _{IL}	LOW-level input voltage	I _I =-18mA	-0.5	-	+0.4	V
V _{IL} V _{ILc}	LOW-level input voltage	I _I =-18mA V _I =5.5V	-0.5 -0.5	- 0.4	+0.4	V V V
V _{IL} V _{ILc} V _{ILK}	LOW-level input voltage LOW-level input voltage contention Input clamping voltage		-0.5 -0.5 -1.2	- 0.4	+0.4 - -0.3	ν ν ν
V _{IL} V _{ILc} V _{ILK} I _{LI}	LOW-level input voltage LOW-level input voltage contention Input clamping voltage Input leakage current	V ₁ =5.5V	-0.5 -0.5 -1.2 -	- 0.4	+0.4 - -0.3 ±1	V V V μ.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	output LOW-level voltage	-50°-				
0		VI=3V or 0V; VCC=3.3V	~	7	10	pF
Cio	Input/output capacitance	VI=3V or 0V; VCC=0V				
nput and	output SDAA and SCLA	- (B)	Sec.			
VIH	HIGH-level input voltage	×	0.7V _{CCA}	-	5.5	V
VIL	LOW-level input voltage	2	^{[[2]} -0.5	1	$0.25V_{CCA}$	V
V _{ILK}	Input clamping voltage	I _I =-18mA	-1.2	1	-0.3	V
ILI	Input leakage current	V ₁ =5.5V	10	3	±1	μA
I _{IL}	LOW-level input current	SDA, SCL; V _I = 0.2V	-	K.	10	μA
V _{OL}	LOW-level output voltage	I _{OL} = 6mA	-	0.1	0.2	V
		VI=3V or 0V; VCC=3.3V		7	10	pF
C _{io}	Input/output capacitance	VI=3V or 0V; VCC=0V				
nable					1	2 De
VIL	LOW-level input voltage		-0.5	-	+0.3V _{CCB}	V
V _{IH}	HIGH-level input voltage		$0.7V_{CCB}$	-	5.5	V
I _{IL(EN)}	LOW-level input current on pin EN	$V_1 = 0.2V, EN; V_{CCB} = 2.2V$	-	-10		μA
I _{LI}	Input leakage current		-1	-	+1	μA
Ci	Input capacitance	$V_I = V_{CCB}$	-	6	7	pF

[1] V_{CCA} may be as high as 5.5V for over voltage tolerance but 0.4VCCA + 0.8V < VCCB for the channels to be enable and functional normally

[2] VIL for A-side with envelope noise must be below 0.3VccA for stable performance

là bà n [3] Power supply decoupling capacitors need to be present for both V_{CCA} and V_{CCB} and the 0.1uF decoupling for V_{CCB} needs to

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Figure 5 - Propagation delay and transition (rise/fall) times; B-side to A-side



Figure 6 - Propagation delay and transition (rise/fall) times; A-side to B-side



6.3 AC CHARACTERISTICS

 $V_{\text{CCA}}=0.8V \text{ to } 5.5V; V_{\text{CCB}}=2.2V \text{ to } 5.5V; \text{ GND}=0V; \text{ } T_{\text{amb}}=-40 ~^{\circ}\text{C to } 85^{\circ}\text{C}; \text{ unless otherwise specified}.$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{PLH}	LOW-to-HIGH propagation delay	B-side to A-side; figure 5	60	90	130	ns
t _{PHL}	HIGH-to-LOW propagation delay	B-side to A-side; figure 5	40	70	100	ns
t _{rise}	Rise time	A-side; figure 5	Xax	100	-	ns
t _{fall}	Fall time	A-side; figure 5	2	4	6	ns
t _{PLH}	LOW-to-HIGH propagation delay	A-side to B-side; figure 6	30	60	80	ns
t _{PHL}	HIGH-to-LOW propagation delay	A-side to B-side; figure 6	40	70	90	ns
t _{rise}	Rise time	B-side; figure 6	- 3	100	A	ns
t _{fall}	Fall time	B-side; figure 6	5	20	35	ns
t _{en}	Enable time	EN HIGH to enable; figure 7	-		200	ns
t _{dis}	Disable time	EN LOW to disable; figure 7	-	-	200	ns

[1] Times are specified with loads of 1.35k pull-up resistance and 50 pF load capacitance on the A/B-side and falling edge slew rate of 0.05V/ns input signals. Different load resistance and capacitance will alter the RC time constant, thereby changing the propagation delay and transition times

[2] Pull-up voltages are VccA on the A-side and VccB on the B-side.

[3] Typical values were measured with Vcca = 0.95 V, VccB = 2.5 V at Tamb = 25 °C, unless otherwise noted.

[4] The enable pin, EN, should only change state when the global bus and the repeater port are in an idle state.





6.4 Test Information



- R_L= load resistor; 1.35K on A/B port
- C_L= load capacitor; 50pF

R_T= termination resistor that should be equal to chacteristic resistance of pulse generation

Figure 8 - Test circuit for open-drain outputs



7. ORDER INSTRUCTION

PART NO.	PACKAGE	SUPPLIED AS		
NCT5927W	MSOP-8	E shape (Tube)		
NG13927W	Green Package	T shape (Tape & Reel); MOQ=4Kpcs		

8. TOP MARKING SPECIFICATION



1st line: Part number: <u>5927W</u> means NCT5927W

2nd line: Assembly tracking code

3 15 : packages made in year 2013, week 15

 $\underline{\mathbf{G}}$: Assembly house code

A: Nuvoton internal tracking code

9. TAPING SPECIFICATION



FEEDING DIRECTION \rightarrow



10. PACKAGE DRAWING AND DIMENSIONS

MSOP-8L 3 X 3mm





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CONTROLLING DIMENSION : MILLIMETERS

	DIMENSION IN MM			DIMENSION IN INCH			
SIMBUL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A			1.10			0.043	
A1	0.05		0.15	0.002		0.006	
A2	0.81	0.86	0.91	0.032	0.034	0.036	
С	0.13		0.23	0.005		0.009	
b	0.25		0.40	0.0098		0.0157	
D	2.90	3.00	3.10	0.114	0.118	0.122	
E	2.90	3.00	3.10	0.114	0.118	0.122	
HE		4.90 BS	iC	0	.193 BS	SC	
L	0.445	0.55	0.648	0.0175	0.0217	0.0255	
θ1	0°		6°	0°		6°	
е		0.65 BS	С	(0.026 B	SC	
						Relea	
	SYMBOL A A1 A2 c b D E HE L U 01	SYMBOL DIME MIN. A A1 0.05 A2 0.81 c 0.13 b 0.25 D 2.90 E 2.90 HE L 0.445 θ1 0°	DIMENSION IN MIN. NOM. A A1 0.05 A2 0.81 0.86 c 0.13 b 0.25 D 2.90 3.00 E 2.90 3.00 HE 4.90 BS L 0.4445 0.55	DIMENSION IN MM SYMBOL MIN. NOM. MAX. A 1.10 A1 0.05 0.15 A2 0.81 0.86 0.91 c 0.13 0.23 b 0.25 0.40 D 2.90 3.00 3.10 E 2.90 3.00 3.10 HE 4.90 BSC L 0.445 0.55 0.648 θ1 0° 6°	SYMBOL DIMENSION IN MM DIMENSION IN MM A 1.10 A1 0.05 0.15 0.002 A2 0.81 0.86 0.91 0.032 c 0.13 0.23 0.005 b 0.25 0.40 0.0098 D 2.90 3.00 3.10 0.114 E 2.90 3.00 3.10 0.114 HE 4.90 BSC C C L 0.445 0.55 0.648 0.0175 θ1 0° 6° 0°	SYMBOL MIN. NOM. MAX. MIN. NOM. A 1.10 A1 0.05 0.15 0.002 A2 0.81 0.86 0.91 0.032 0.034 c 0.13 0.23 0.005 b 0.25 0.40 0.0098 D 2.90 3.00 3.10 0.114 0.118 E 2.90 3.00 3.10 0.114 0.118 HE 4.90 BSC 0.193 BS L 0.445 0.55 0.648 0.0175 0.0217 θ1 0° 6° 0° C C C C	



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